### **TFAWS Passive Thermal Paper Session**



# Correlation of the SAGE III on ISS Thermal Models to Test and Flight Data

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ANALYSIS WORKSHOP

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#### **Agenda**



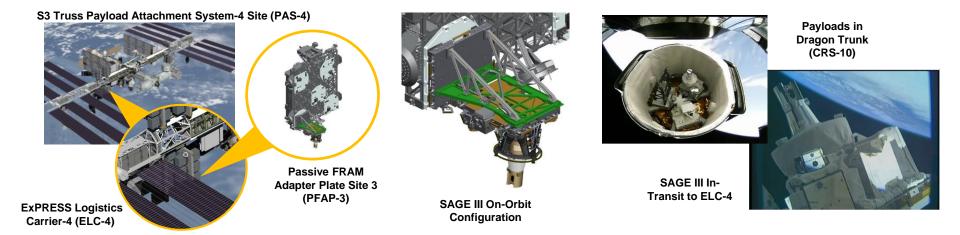
- SAGE III on ISS background
- Approach to Thermal Vacuum (TVAC) Testing and Correlation
- TVAC Correlation Achievements and Lessons Learned
  - Interface Adapter Module TVAC
  - Instrument Assembly TVAC
  - Chamber Characterization
  - Instrument Payload TVAC
  - Summary of lessons learned
- Correlation to Flight Data
- Summary



### **SAGE III on ISS Background**



- Stratospheric Aerosol and Gas Experiment
- Fifth in a series of instruments developed to monitor ozone, aerosols, and other trace gases in Earth's stratosphere and troposphere
- Partnership between NASA Langley Research Center (LaRC), Thales Alenia Space- Italy (TAS-I), and Ball Aerospace and Technologies Company (BATC)
- Launched to the International Space Station (ISS) via Space X Falcon 9 in February 2017
- Consists of two payloads Instrument Payload (IP) and Nadir Viewing Platform (NVP)





### **Instrument Payload (IP)**



Sensor Assembly (SA)

Hexapod Mechanical Assembly (HMA)

Contamination
Monitoring Package
(CMP) 2

Disturbance Monitoring Package (DMP)

Instrument Control Electronics (ICE)

Hexapod Electronics Unit (HEU)

Contamination
Monitoring Package
(CMP) 1

Interface Adapter Module (IAM)

ExPRESS Payload Adapter (ExPA)



#### **General TVAC Test Approach**



- All TVAC test scenarios modeled in Thermal Desktop® (TD) within system flight model
- Primary goals:
  - Evaluate behavior in vacuum at hot and cold conditions
  - Obtain data for model correlation
- Test profiles included these 5 thermal balances:
  - Unpowered hot & cold
  - Heater-only cold
  - Operational hot & cold
- Transient unpowered cool-down with constant environment included in test profile



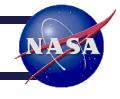
### **General Correlation Approach**



- Pre-test model predictions used as starting point
- Thermal model correlated to balances and transient power-on and power-off
  - Unpowered cases completed first; fewest variables
- Measurements included flight sensors, test TCs, and subsystem current draw
- Main adjustments made during correlation:
  - Contacts between parts
  - Optical properties
  - Component dissipated power
- Transient analysis performed for better accuracy
- Root-mean-square (RMS) errors calculated over entire timeline, all sensors
- Goal for model correlation: RMS error < 5°C</li>



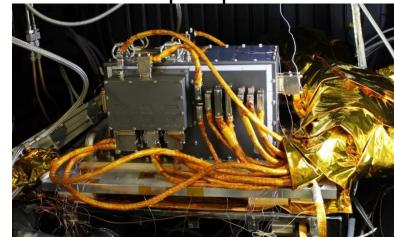
#### **Interface Adapter Module (IAM) TVAC**



- New build, flight computer and power distribution unit
- MLI on back, silver Teflon all other sides
- Operational and survival heaters controlled via mechanical thermostats
- Tightly-coupled to chamber interface plate in flight-like configuration using thermal epoxy
- Primary adjustments made in correlation:
  - Power dissipation

Conductors from boards to chassis, chassis to adapter plate







## **IAM Correlation Quality**



Overall RMS error is less than 2°C - indicates excellent correlation

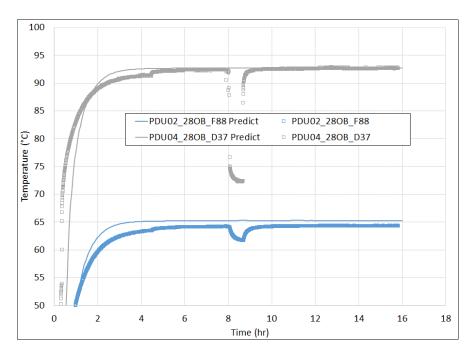
Steady-State Results	Hot Unpowered	Hot Powered	Cold Unpowered	Cold Powered	Overall RMS
Overall RMS error (°C)	1.7	1.1	1.0	3.1	1.9
Flight sensor RMS error (°C)	0.9	1.1	0.7	3.7	2.0
Avg error (°C)	0.4	0.4	-0.7	-1.5	-0.4

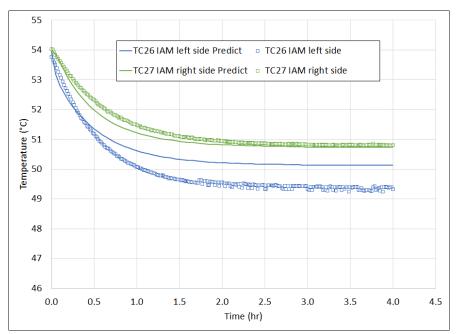
Transient Results	Hot Cooldown
Overall RMS error (°C)	1.1
Flight sensor RMS error (°C)	1.2
Avg error (°C)	0.1



#### **IAM Correlation Plots**







Hot Powered Steady-State

4-hr Cool-Down Transient



#### **IAM TVAC Correlation Lessons Learned**



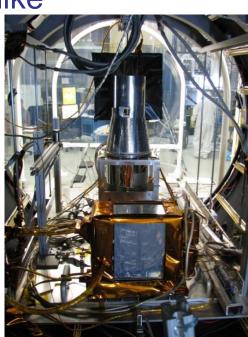
- Test TCs should be attached with high-conductivity tape to minimize error if TC bead lifts off surface
- Mock payload interfaces should be as flight-like as possible for subsystem-level TVAC
  - Surface characteristics (roughness, finish, etc.)
  - Fastener torque specifications
  - More temperature sensors typically available to characterize interface



### **Instrument Assembly (IA) TVAC**



- Consists of the Sensor Assembly (SA) and Instrument Control Electronics (ICE)
  - Hardware built in late 1990's
- IA contains heaters, rotating azimuth motor, rotating scan mirror, thermo-electric cooler (TEC)
- Exterior surfaces mainly silver-Teflon
- Conductive interfaces designed to be flight-like
- Quartz lamps used for heating (6 zones)
- Primary adjustment made in correlation
  - Contact between parts





### **IA Correlation Quality**



- Overall RMS error for flight sensors less than 1.5°C indicates excellent correlation
- Main adjustments were to contacts

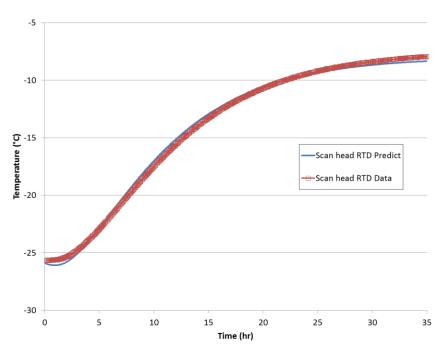
Balance Results	Hot Unpowered	Hot Powered	Cold Unpowered	Cold Heater-only	Cold Powered	Overall Average
Overall RMS error (°C)	1.5	1.7	1.3	2.8	3.9	2.4
Flight sensor RMS error (°C)	0.6	2.2	0.5	1	1.8	1.4
Avg error (°C)	0.0	-0.6	0.3	1.1	0.6	0.3

Transient Results	Hot Powerup	Hot Cooldown	Cold Powerup	Cold Heater Powerup	Cold Cooldown	Overall Average
Overall RMS error (°C)	1.4	0.4	2.4	2.8	1.0	2.0
Flight sensor RMS error (°C)	1.4	0.6	1.2	1.7	0.9	1.3
Avg error (°C)	-0.1	0.1	1.3	0.8	-0.7	0.3

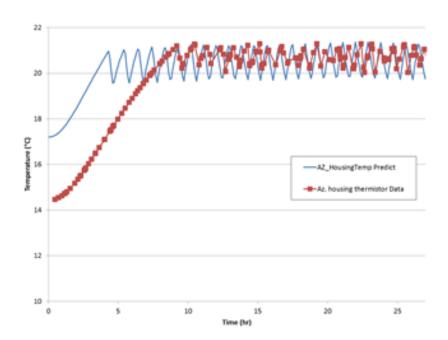


#### **IA Correlation Plots**





Cold power-on transient



Azimuth heater operation



#### **IA TVAC Correlation Lessons Learned**



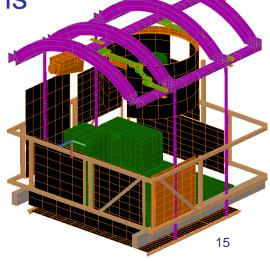
- Correlation of heater operation to heater-only balance worked well
- Unpowered cool-downs helpful in thermal mass correlation
- Transient cases provide more accurate prediction of behavior, even for quasi-steady-state
- Correlation of TEC behavior
  - Required modification of TEC parameters due to degradation
  - Test data when TEC data went out of the control range valuable
- Chamber shroud had larger gradients than expected, should be well-instrumented
- Issues with quartz lamps led to facility characterization test to perform IA model correlation
  - Fraction of infrared (IR) vs. solar
  - No power measurement



#### **TVAC Chamber Characterization**



- Heater plate system designed for payload-level test
  - Avoids quartz lamps
  - Allows for independent control of subsystems
- Test to characterize heater plate system
  - Verify capability to achieve target temperatures
  - Determine heater plate gradients
  - Correlate thermal model of chamber
- Test paused to remove MLI from two plates to achieve goal temperatures; repeated test conditions
- Primary correlation adjustments:
  - MLI
  - Plate emissivity
  - Contact between plates and frame
  - Mesh on plates





### **Characterization Correlation Quality**



- Overall RMS error for final configuration below 5°C indicates good correlation
  - Errors higher in original configuration due to using standard TD modeling method for MLI covering surfaces at different temperatures
  - Slight tendency toward over-prediction
- Model accurately tracked response of neighboring plates to heater power changes - gives a high level of confidence in the model

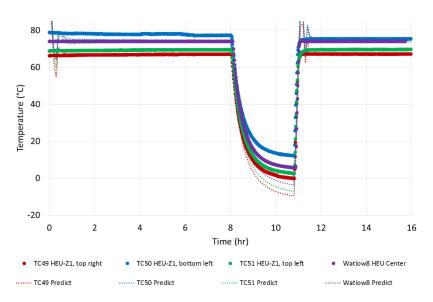
		Hot Survival	Hot Op	Cold Survival	Hot Op 2	Cold Survival 2	Overall Average
Errors on mock payload and ExPA (°C)	RMS error	4.8	4.7	5.8	1.9	3.8	4.2
	Average error	4.5	0.7	-1	-1.5	3.1	1.2
Errors on heater plates	RMS error	3.4	3.4	3.9	2.9	3	3.3
and frame (°C)	Average error	2.1	0.9	-1.5	1.4	1.4	0.9

**Configuration Change** 

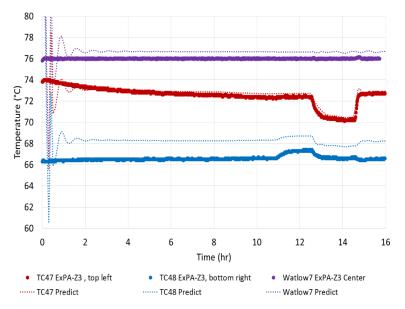


#### **Characterization Correlation Plots**





Heater plate cooldown correlation



Neighboring plate reaction to cooldowns



### **Characterization Lessons Learned**



- For MLI covering multiple plates at different temperatures, cannot use Insulation tab on TD surface
  - Insulation must be modeled explicitly to get correct radiative transfer under MLI
- Place temperature sensors to verify basic assumptions, such as thermal contact between parts
- Chamber emissivity lower than assumed at cold conditions
- Plate gradients ~10°C despite even distribution of heaters across aluminum plates
  - Well-predicted following correlation

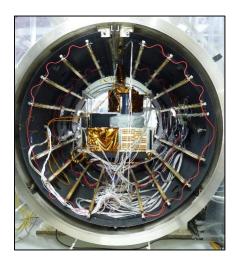


### **Instrument Payload (IP) TVAC**



- Flight IP and custom heater plate system
- IP contains operational and survival heaters, multi-layer insulation (MLI), silver Teflon, and TECs
- Included orbit simulations for correlation to a flight-like transient motor power profile
- Primary adjustments made in correlation:
  - Contact between trolley and chamber
  - Emissivity
  - MLI effective emissivity
  - Conductance to the ExPA and between parts







### **Overall IP Correlation Quality**



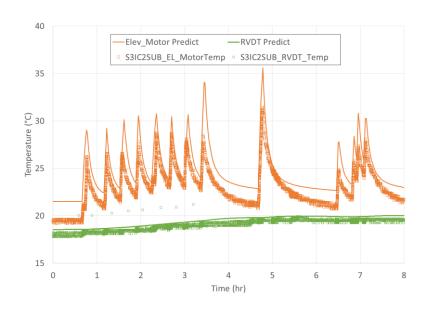
- Facility thermocouple data not included in RMS error calculations due to excessive noise
- Overall RMS error is less than 2.5°C indicates remarkable correlation for a complex model
  - Slight tendency toward under-prediction

	Hot Unpowered	Cold Unpowered	Hot Powered	Cold Powered	Hot Cooldown	Cold Cooldown	Overall average
RMS error for flight sensors (°C)	1.1	2.7	1.7	2.8	3.2	2.6	2.4
Avg error for flight sensors (°C)	-0.9	-0.1	0.1	0.8	-2.3	-1.2	-0.6

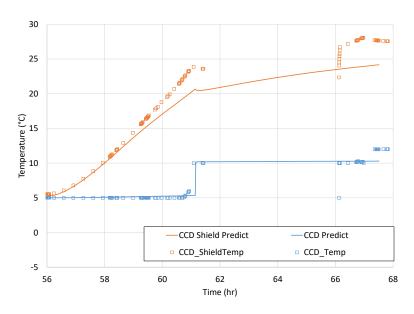


#### **IP Correlation Plots**





Correlation to operation of elevation motor during science events

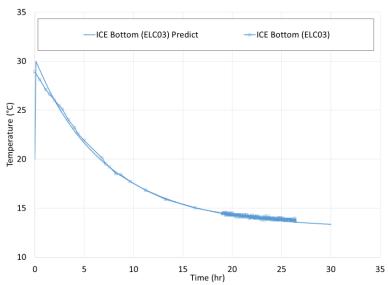


Correlation to operation of heater and TEC

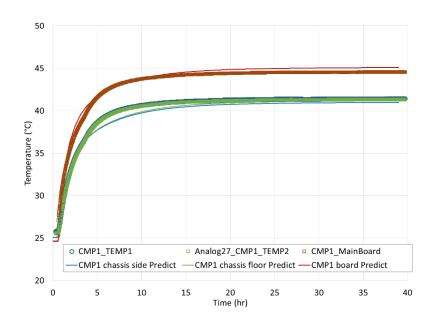


#### **IP Correlation Plots**





Hot unpowered transient correlation



Hot powerup transient correlation



#### **IP Correlation Lessons Learned**



- High noise observed in test TCs due to wire routing check prior to test start
- Balance sequence effective for correlation
  - Unpowered correlation first, quasi-steady-state and then transient
  - Transient for heater power-up
  - Transient to powered operation
  - Powered balance
  - Power-off for cooldown transient
- Accurate power calculations required measured current and resistance
- Run time reduced via modification of TEC power dissipation equation



### Flight Correlation



- SAGE III launched on SpaceX CRS-10 mission in February
- Operational on ELC-4 since March 10<sup>th</sup>
- Beta angle range experienced to-date between -38° and +73°
- Primary areas of focus:
  - Worst-case beta angles for hot operations
  - Elevation motor temperature during science events
  - ExPA temperature at high-negative beta
- Major model adjustments:
  - Power
  - Optical properties
  - Conductors between internal instrument parts



### Flight Correlation Quality



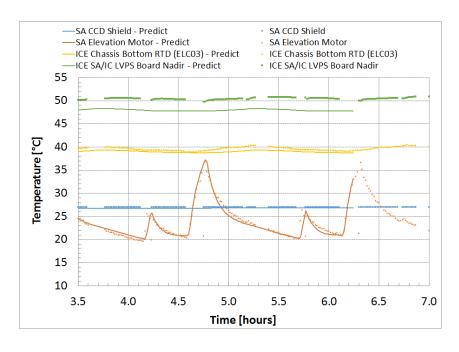
- Beta 41° worst-case hot case for most components
  - Good matching; overall RMS error is < 3°C</li>
- Beta -38° worst-case hot case for SA (to-date)
  - Good matching for SA
  - ExPA-coupled components under-predicting by up to 12°C

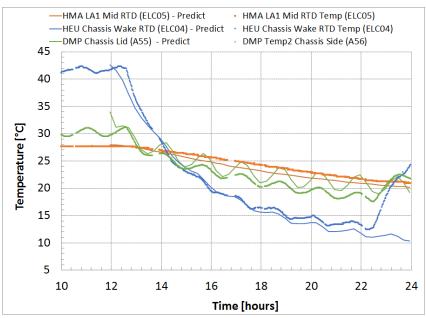
	β = 73°	β = 50°	β = 41°	β = -24°	β = -38°	Overall
RMS error for flight sensors (°C)	8.4	3.9	2.6	3.7	4.3	4.6
Avg error for flight sensors (°C)	8.0	3.1	-0.3	-2.7	-3.4	1.0



### **Flight Correlation Plots**







Limb-Scatter Event Correlation  $(\beta = 41^{\circ})$ 

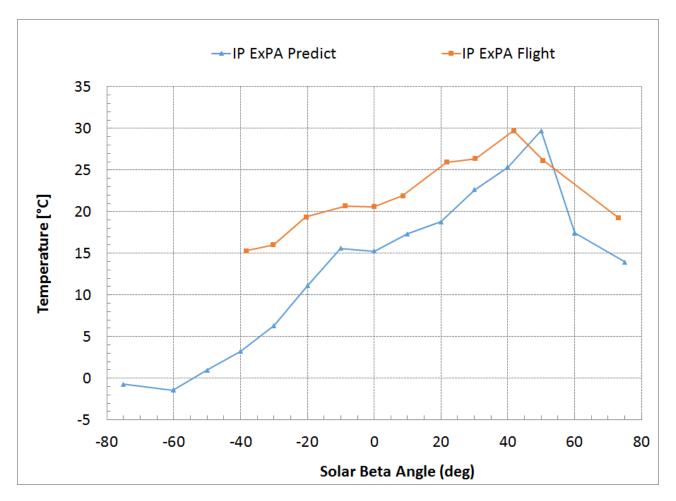
Unpowered Correlation 
$$(\beta = 45^{\circ})$$



# **ExPA Temp as a Function of Beta Angle**



ExPA under-prediction increases as beta becomes more negative





#### **Conclusions**



- Model quality very good: overall TVAC RMS error < 3°C</li>
- Lessons learned: test definition and setup
  - Create test conditions focused on thermal behavior for correlation
  - Quartz lamps solar output can make correlation problematic
  - Characterizing new chamber equipment prior to payload testing is highly beneficial
  - Ensure TCs placed so basic assumptions can be verified
  - Make interfaces as flight like as possible
- Lessons learned: correlation
  - Best practice proceed from simple to complex; correlate to hot and cold
  - Correlation to transients more reliable than to steady-state
  - Use of single model for flight and ground test scenarios greatly improves efficiency
  - RMS error very effective single measure of model quality
- Correlation, though complex, is worthwhile for flight predicts and finding systemic errors in the model



### **Acknowledgements**



 Thank you to the SAGE III project personnel, and the Systems Integration and Test branch personnel, for support in accomplishing this TVAC testing.